

Part Number: XZUYMG56W

3.0mmx1.0mm RIGHT ANGLE SMD CHIP LED LAMP

Features

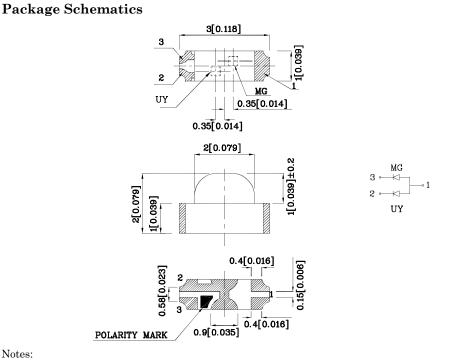
- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel

Part

Number

- MSL (Moisture Sensitivity Level): 3
- \bullet RoHS compliant





1. All dimensions are in millimeters (inches).

2. Tolerance is $\pm 0.15 (0.006")$ unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		UY (GaAsP/ GaP)	MG (GaP)	Unit	
Reverse Voltage	V_{R}	5	5	v	
Forward Current	$\mathbf{I}_{\mathbf{F}}$	30	25	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	140	mA	
Power Dissipation	\mathbf{P}_{D}	75	62.5	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85		°C	
Storage Temperature	Tstg	-40 ~	- +85	C	

Operating Characteristics (T _A =25°C)	UY (GaAsP/ GaP)	MG (GaP)	Unit	
Forward Voltage (Typ.) (I _F =20mA)	$V_{\rm F}$	2.1	2.2	v
Forward Voltage (Max.) (I _F =20mA)	$V_{\rm F}$	2.5	2.5	v
Reverse Current (Max.) (V _R =5V)	I_R	10	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =20mA)	λP	590*	565*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =20mA)	λD	588*	568*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$ riangle \lambda$	35	30	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	20	15	$_{\rm pF}$
Lens-color Luminous In CIE127-2 (I _F =20m mcd	007*	Wavelen CIE127-2 nm λP	~ V10W	gle

				min.	typ.		
XZUYMG56W —	Yellow	GaAsP/GaP	Water Clear	5*	7*	590*	- 140°
	Green	GaP		5*	14*	565*	

Emitting

Material

*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards. Mar 07,2014

Emitting

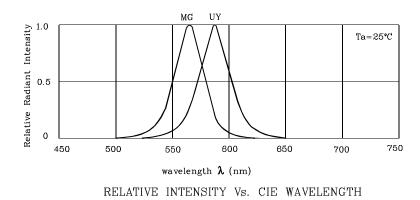
Color

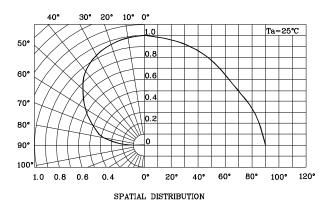
XDSA1560 V8-Z Layout: Maggie L.



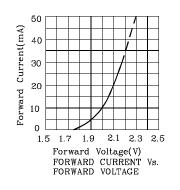
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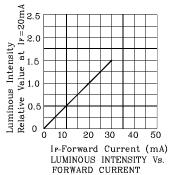
LAMP

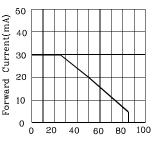




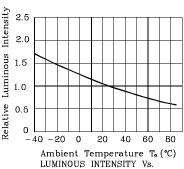
♦ UY





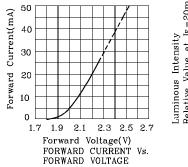


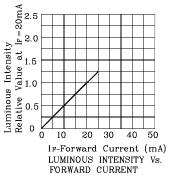


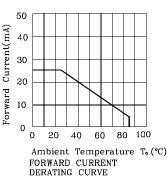


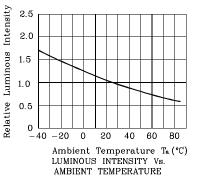
AMBIENT TEMPERATURE

* MG







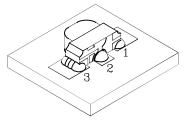




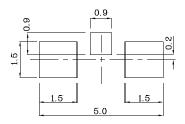
LED is recommended for reflow soldering and soldering profile is shown below.

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***** The device has a single mounting surface. The device must be mounted according to the specifications.

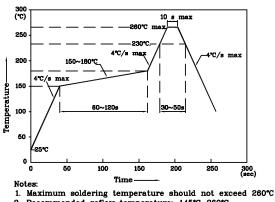


Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



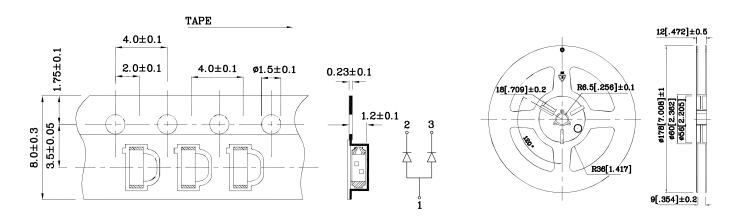
Reel Dimension

Reflow Soldering Profile for SMD Products (Pb-Free Components)



- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

***** Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

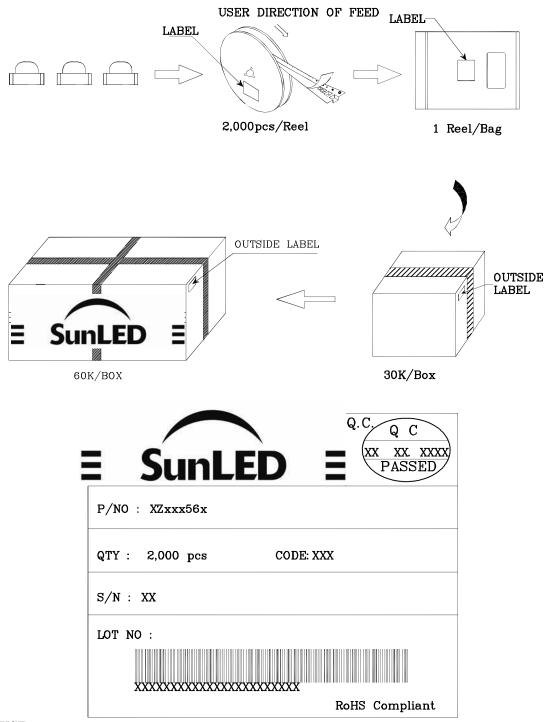
2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at <u>http://www.SunLEDusa.com/TechnicalNotes.asp</u>